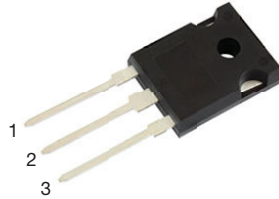
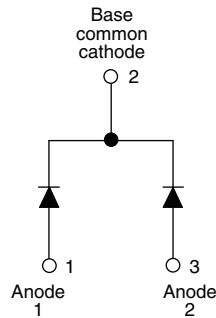


## Ultrafast Soft Recovery Diode, 2 x 30 A FRED Pt<sup>®</sup> Gen 4



TO-247AD 3L



### FEATURES

- Gen 4 FRED Pt<sup>®</sup> technology
- Low  $I_{RRM}$  and reverse recovery charge
- Very low forward voltage drop
- Polyimide passivated chip for high reliability standard
- 175 °C operating junction temperature
- Designed and qualified according to JEDEC<sup>®</sup>-JESD 47
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 x 30 A
$V_R$	600 V
$V_F$ at $I_F$	1.19 V
$t_{rr}$ typ.	See Recovery table
$T_J$ max.	175 °C
Package	TO-247AD 3L
Circuit configuration	Common cathode

### DESCRIPTION

Gen 4 Fred technology, state of the art, ultralow  $V_F$ , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Peak repetitive reverse voltage	$V_{RRM}$		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 131$ °C	30	A
Non-repetitive peak surge current, per leg	$I_{FSM}$	$T_C = 25$ °C, $t_p = 8.3$ ms, half sine wave	240	
Operating junction and storage temperature	$T_J, T_{Stg}$		-55 to +175	°C

ELECTRICAL SPECIFICATIONS ( $T_J = 25$ °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 100$ $\mu$ A	600	-	-	V
Forward voltage	$V_F$	$I_F = 30$ A	-	1.36	1.6	
		$I_F = 60$ A	-	1.6	-	
		$I_F = 30$ A, $T_J = 125$ °C	-	1.23	-	
		$I_F = 60$ A, $T_J = 125$ °C	-	1.5	-	
		$I_F = 30$ A, $T_J = 150$ °C	-	1.19	1.35	
Reverse leakage current	$I_R$	$V_R = V_R$ rated	-	-	50	$\mu$ A
		$T_J = 125$ °C, $V_R = V_R$ rated	-	-	500	
Junction capacitance	$C_T$	$V_R = 600$ V	-	18.3	-	pF



DYNAMIC RECOVERY CHARACTERISTICS ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$T_J = 25\text{ }^\circ\text{C}$	$I_F = 30\text{ A}$ $dI_F/dt = 1000\text{ A}/\mu\text{s}$ $V_R = 400\text{ V}$	-	65	-	ns
		$T_J = 125\text{ }^\circ\text{C}$		-	90	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$		-	18	-	A
		$T_J = 125\text{ }^\circ\text{C}$		-	32	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^\circ\text{C}$		-	850	-	nC
		$T_J = 125\text{ }^\circ\text{C}$		-	1850	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance, junction to case	$R_{thJC}$		-	-	1	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to ambient	$R_{thJA}$	Typical socket mount	-	-	40	
Thermal resistance, case to heat sink	$R_{thCS}$		-	0.4	-	
Weight			-	6.0	-	g
			-	0.21	-	oz.
Mounting torque			6.0 (5)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style TO-247AD 3L	C4PU3006L			

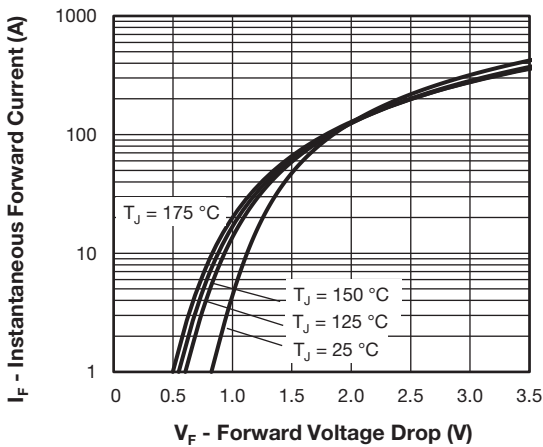


Fig. 1 - Typical Forward Voltage Drop Characteristics

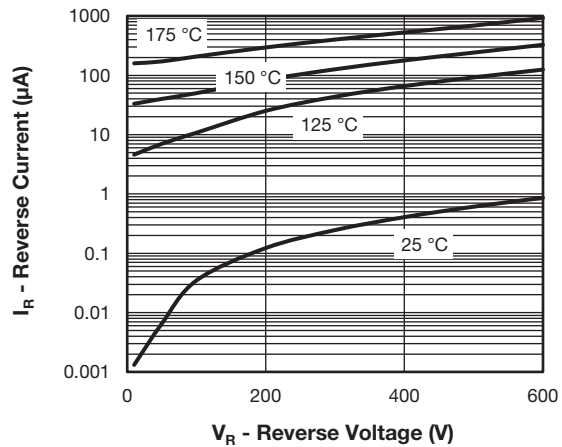


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

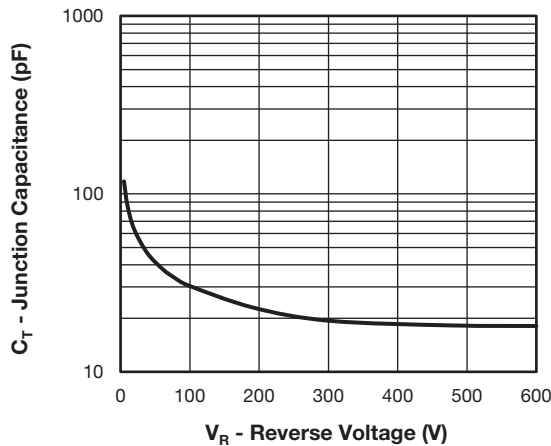


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

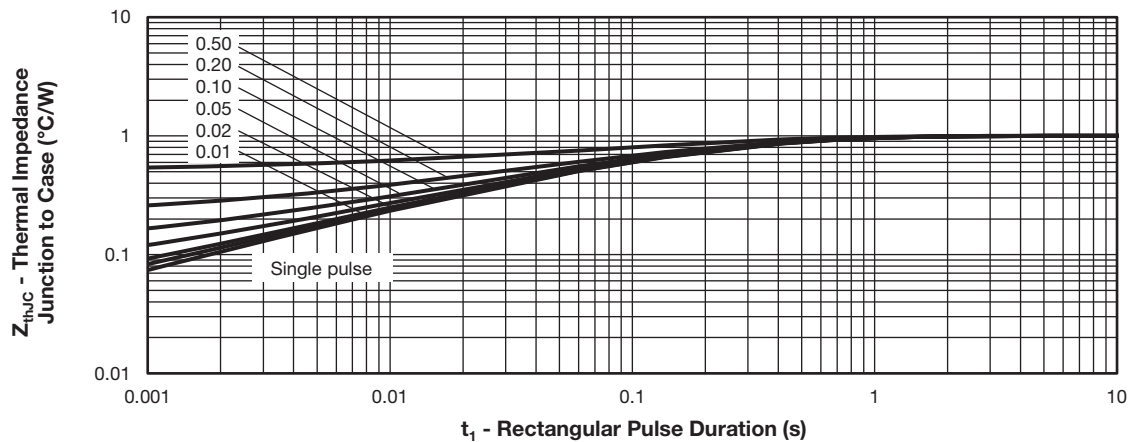


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

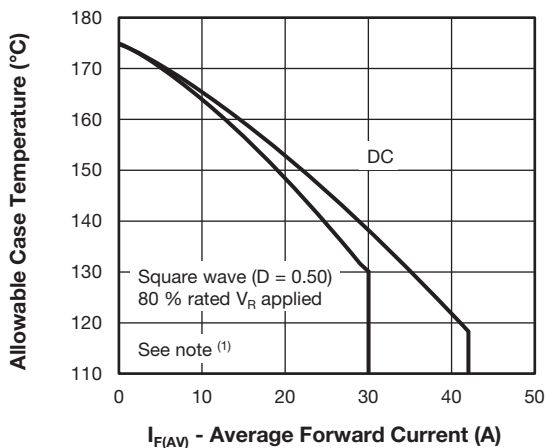


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

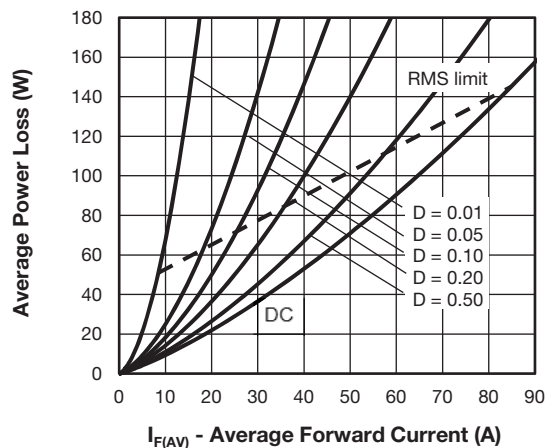


Fig. 6 - Forward Power Loss Characteristics

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see Fig.5)  
 $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_R$  = rated  $V_R$

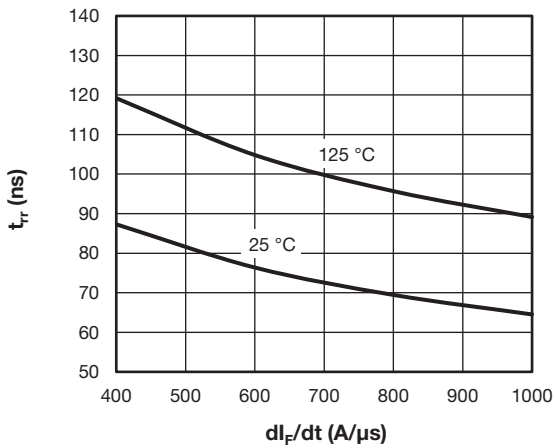


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$

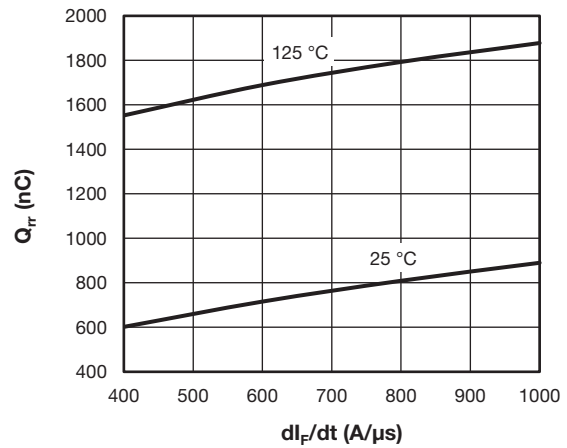


Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$

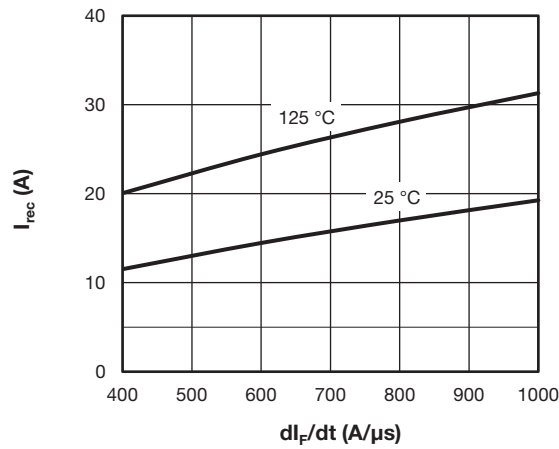
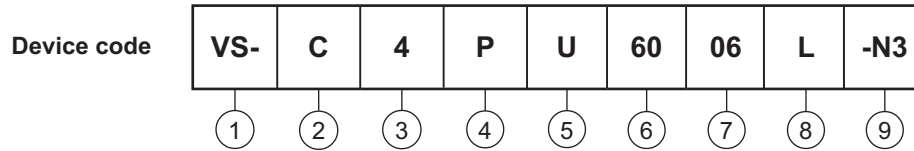


Fig. 9 - Typical Reverse Current vs.  $dI_F/dt$



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Circuit configuration:  
C = common diode
- 3** - FRED Pt Gen 4
- 4** - P = TO-247 package
- 5** - Process type:  
U = ultrafast recovery
- 6** - Current rating (60 = 2 x 30 A)
- 7** - Voltage rating (06 = 600 V)
- 8** - Package: L = long lead
- 9** - Environmental digit:  
-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-C4PU6006L-N3	25	500	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95626">www.vishay.com/doc?95626</a>
Part marking information	<a href="http://www.vishay.com/doc?95007">www.vishay.com/doc?95007</a>

### TO-247AD 3L

**DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
A	4.65	5.31	0.183	0.209		D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102		E	15.29	15.87	0.602	0.625	3
A2	1.50	2.49	0.059	0.098		E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055		e	5.46 BSC		0.215 BSC		
b1	0.99	1.35	0.039	0.053		Ø K	0.254		0.010		
b2	1.65	2.39	0.065	0.094		L	19.81	20.32	0.780	0.800	
b3	1.65	2.34	0.065	0.092		L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135		Ø P	3.56	3.66	0.14	0.144	
b5	2.59	3.38	0.102	0.133		Ø P1	-	6.98	-	0.275	
c	0.38	0.89	0.015	0.035		Q	5.31	5.69	0.209	0.224	
c1	0.38	0.84	0.015	0.033		R	4.52	5.49	0.178	0.216	
D	19.71	20.70	0.776	0.815	3	S	5.51 BSC		0.217 BSC		
D1	13.08	-	0.515	-	4						

**Notes**

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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